Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
# L2	21	(plastic polymer) with lid with mems	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:04
L3	43	(plastic polymer) with window with mems	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:04
L4 ·	3	(plastic polymer) with window with mems and thermal near3 bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR .	ON	2008/01/08 10:08
L5	0	(plastic polymer) with sealet with mems and thermal near3 bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:08
L6	0	(plastic polymer) with sealent with mems and thermal near3 bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON .	2008/01/08 10:08
L7	0	(plastic polymer) with sealant with mems and thermal near3 bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:08
L8	1	(plastic polymer) with cover with mems and thermal near3 bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:09
L9	75	(plastic polymer) with cover and thermal near3 bond\$3 and mems	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:55
L10	45	(plastic polymer) with cover and thermal near3 bond\$3 same (laser wavelength) and mems	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON .	2008/01/08 10:56

144	45	(plastic polymer) with (lid cover) and thermal	US-PGPUB;	OR	ON	2008/01/08 10:57
L11	<del>4</del> 5	near3 bond\$3 same (laser wavelength) and mems	USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB			
L12		(plastic polymer) with (lid ) and thermal near3 bond\$3 same (laser wavelength) and mems	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR .	ON	2008/01/08 10:59
L13	3451	(plastic polymer) with (lid ) and thermal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:58
L14	635	13 and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:58
L15	5	(plastic polymer) with (lid ) and thermal near3 bond\$3 same (laser wavelength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 11:00
L16	115	laminate with (cover lid) and mems	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 11:48
L17	. 2	("6470594").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2008/01/08 12:18
L18	46	thermal adj bond\$3 with mask	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 12:22
L19	0	thermal adj bond\$3 with sheild .	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 12:22

L20	. 34	thermal adj bond\$3 with shield	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 12:33
L24	338	(438/25).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2008/01/08 12:41
L25	223	(438/116).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2008/01/08 12:41
L26	<b>549</b>	24 25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 12:42
L27	1102430	26 (shield mask)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR .	ON	2008/01/08 12:42
L28	201	26 and (shield mask)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 12:42
S1	2	("20050260828").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2007/05/14 16:26
S2	0	("2005/0260828").URPN.	USPAT	OR	ON	2007/05/14 16:30
S3	5503	irradiat\$4 with bond\$4	USPAT	OR	ON	2007/05/14 16:34
S4	9610	transparent adj (cover\$3)	USPAT	OR	ON	2007/05/14 16:31
S5	32	absorbed near3 (second first) adj substrate	USPAT	OR	ON	2007/05/14 16:35
S6	0	S5 same S3	USPAT	OR	ON	2007/05/14 16:31
S7	3	irradiat\$4 same S5	USPAT	OR	ON	2007/05/14 16:32
S8	1	S3 and S5	USPAT	OR	ON	2007/05/14 16:34
S9	95	absorbed with (second first) adj substrate	USPAT	OR	ON	2007/05/14 16:35
S10	5	S9 same bond\$4	USPAT	OR	ON	2007/05/14 17:52
S11	110	mask with bond\$4 same irradiat\$4	USPAT	OR	ON	2007/05/14 17:54
S12	270	mask with bond\$4 with glass	USPAT	OR	ON	2007/05/14 17:57

S13	1476	(438/455).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR ·	OFF	2007/05/14 17:58
S14	539	S13 and mask	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2007/05/14 17:58
S15	329	S14 and glass	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2007/05/14 17:58
S16	42665	(shield mask) same bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2007/05/14 17:59
S17	193	S13 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2007/05/14 17:59
S18	135	S17 and (glass quartz)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2007/05/14 18:00
S19	4381744	(laser light wavelength irratiat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2007/05/14 18:03
S20	98	S18 and S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2007/05/14 18:03
S21	13	mems with packag\$3 with plastic with cover	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/08 10:01